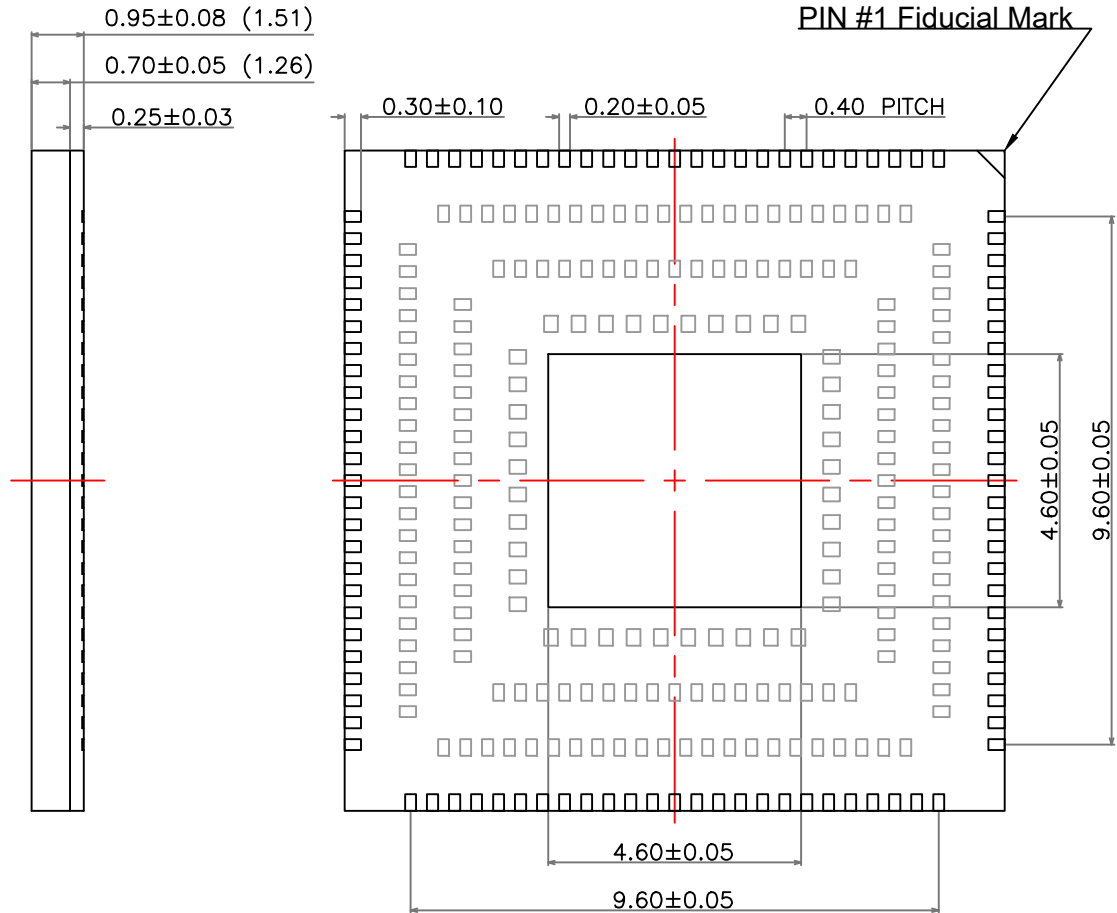


TOP VIEW



SIDE VIEW

BOTTOM VIEW

NOTES :

1. DRAWING CONFORM TO JEDEC
2. ALL DIMENSIONS ARE IN MILLIMETERS
3. SOLDERABLE EXPOSED PAD : 4.60 X 4.60 MM
4. DIMENSIONING AND TOLERANCING PER JEDEC
5. DIVERSIFICATION OF THE PKG OUTLINE IS POSSIBLE AS A LAND RADIAL TYPE

| DESIGNED BY  | CHECKED BY | CHECK BY | APPROVED BY | TITLE  |           |        |
|--|------------|----------|-------------|--|-----------|--------|
| K.S.YUN  |            |          |             | <b>PKG OUTLINE DIMENSION<br/>MLQFN 100LD 12x12mm</b> |           |        |
| 10/01/2023   |            |          |             | UNIT   | TOLERANCE | SCALE  |
| <b>SNPT</b><br>(Semiconductor And Packaging Testing Corporation) |            |          |             | MM   | -         | 1:1    |
|  |            |          |             | DWG NO.  | SPEC NO.  | SHEET  |
|  |            |          |             | POD-MLQFN-12100                                      | MLQFN-02  | 1 OF 1 |